

### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain Source Voltage	VDSS	50	V
Gate-Source Voltage	Vgss	±20	V
Drain Current (Note 5)	I <sub>D</sub>	360	mA

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P <sub>D</sub>	310	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θ</sub> JA	411	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

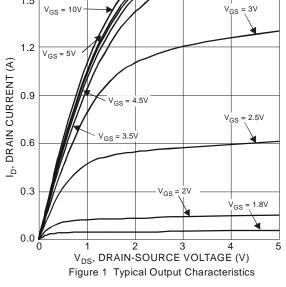
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

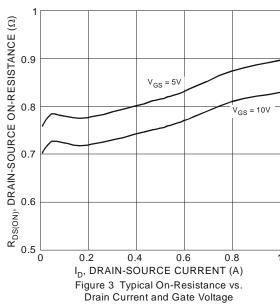
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BVDSS	50	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1.0	μΑ	V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0V
Gate-Body Leakage	Igss	_	_	10	μA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.8	_	1.5	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
Static Drain-Source On-Resistance	RDS(ON)		1.0 1.0 1.4	1.6 2.5 4.5	Ω	$V_{GS} = 10V, I_D = 500mA$ $V_{GS} = 4.5V, I_D = 200mA$ $V_{GS} = 2.5V, I_D = 100mA$
Source-Drain Diode Forward Voltage	VsD		0.8	1.4	V	Vgs = 0V, Is = 500mA
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	C <sub>iss</sub>	_	46	_	pF	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1.0MHz
Output Capacitance	Coss		5.3	_	pF	
Reverse Transfer Capacitance	Crss		4.0	_	pF	
Total Gate Charge	Qg		0.6	_	nC	V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 10V, I <sub>D</sub> = 250mA
Gate-Source Charge	$Q_{gs}$		0.2	_	nC	
Gate-Drain Charge	Qgd		0.1	_	nC	
Turn-On Delay Time	tD(ON)		2.7	_	ns	$V_{DD} = 30V, V_{GS} = 10V,$ $R_{G} = 25\Omega, I_{D} = 200mA$
Turn-On Rise Time	t <sub>R</sub>	_	2.5	_	ns	
Turn-Off Delay Time	tD(OFF)	_	19		ns	
Turn-Off Fall Time	tF	_	11	_	ns	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.







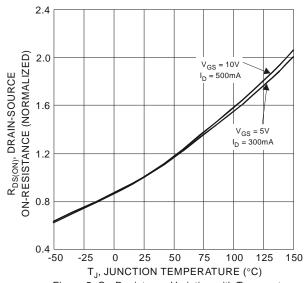
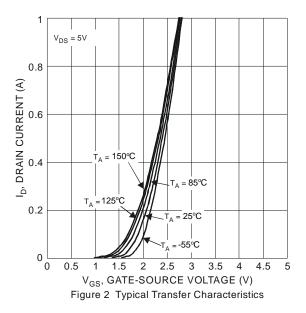
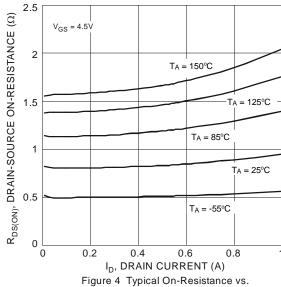


Figure 5 On-Resistance Variation with Temperature





Drain Current and Temperature

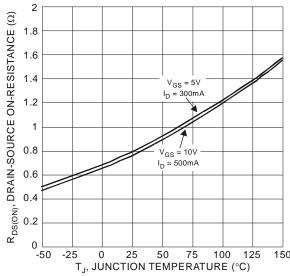


Figure 6 On-Resistance Variation with Temperature



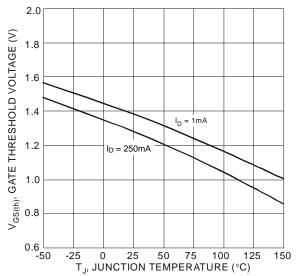
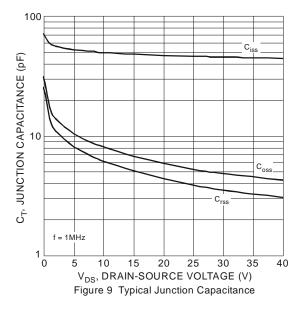
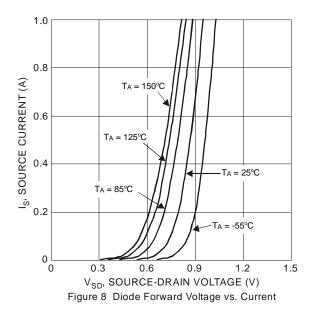
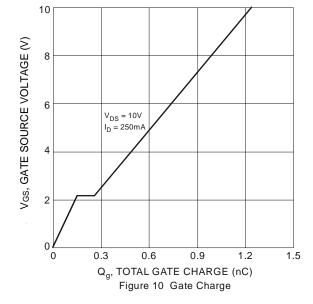


Figure 7 Gate Threshold Variation vs. Ambient Temperature



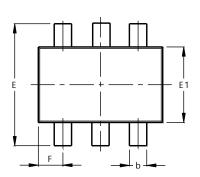


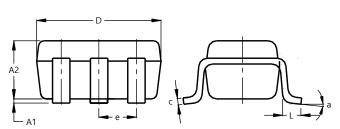




### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



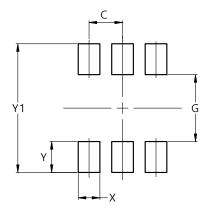


SOT363				
Dim	Min	Max	Тур	
A1	0.00	0.10	0.05	
A2	0.90	1.00	0.95	
b	0.10	0.30	0.25	
C	0.10	0.22	0.11	
D	1.80	2.20	2.15	
Е	2.00	2.20	2.10	
E1	1.15	1.35	1.30	
е	0.650 BSC			
F	0.40	0.45	0.425	
١	0.25	0.40	0.30	
а	0°	8°		
All Dimensions in mm				

# **Suggested Pad Layout**

#### SOT363

**SOT363** 



Dimensions	Value		
Dilliciisions	(in mm)		
С	0.650		
G	1.300		
Х	0.420		
Υ	0.600		
Y1	2.500		

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